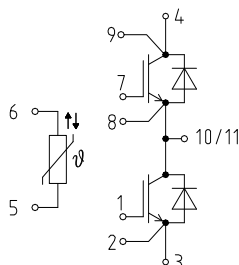
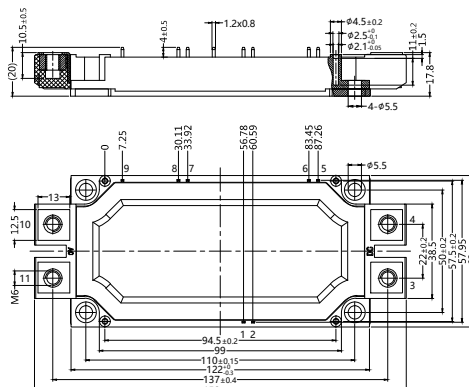


SGG600T120UC5

IGBT Modules



Dimensions in mm (1mm = 0.0394")



$T_c = 25^{\circ}\text{C}$, unless otherwise specified

Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1200	V
I_{Cnom}	$T_c = 100^{\circ}\text{C}$	600	A
I_{CRM}	$T_c = 25^{\circ}\text{C}$, $t_p = 1\text{ms}$	1200	A
V_{GES}		± 20	V
T_{vj}		$-40 \dots +175$	$^{\circ}\text{C}$
Inverse Diode			
I_F	$T_c = 100^{\circ}\text{C}$	600	A
I_{FRM}	$T_c = 25^{\circ}\text{C}$, $t_p = 1\text{ms}$	1200	A
I_{FSM}	$t_p = 10\text{ms}$; $\sin 180^{\circ}$; $T_i = 25^{\circ}\text{C}$	2730	A
Module			
$I_t(\text{RMS})$	$T_{terminal} = 80^{\circ}\text{C}$	600	A
T_{stg}		$-40 \sim 125$	$^{\circ}\text{C}$
V_{isol}	AC, 1min	4000	V

Features

- Trench FS technology
- Low switching losses
- Square RBSOA, no latch up
- High short circuit capability
- Positive temperature coefficient for easy paralleling
- Soft switching FWD Technology
- Package with copper base plate
- Isolation voltage 4000 V
- RoHS Compliant

Application

- AC and DC motor control
- AC servo and robot drives
- Power supplies
- Welding inverters

Advantages

- Space and weight savings
- Reduced protection circuits

SGG600T120UC5

IGBT Modules

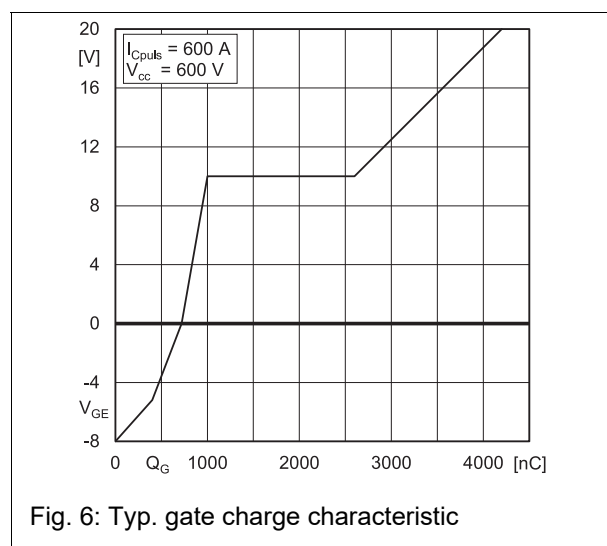
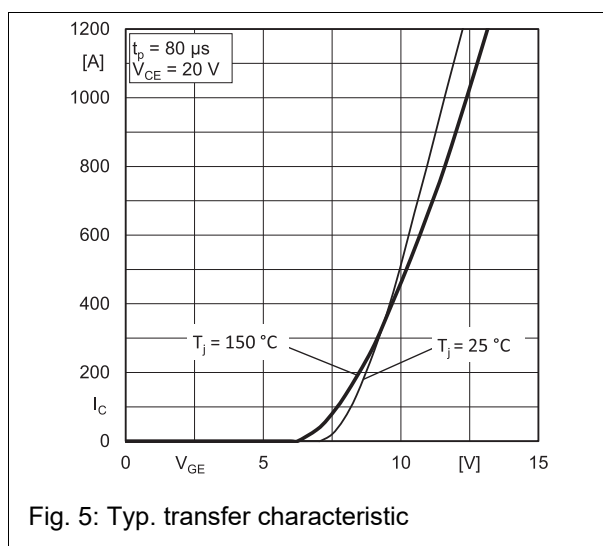
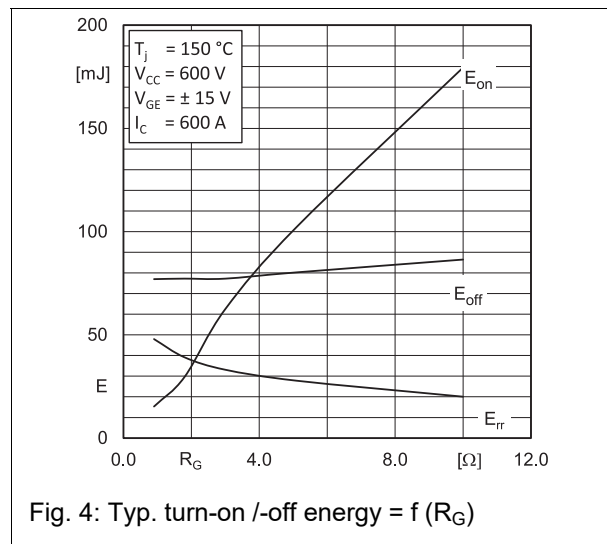
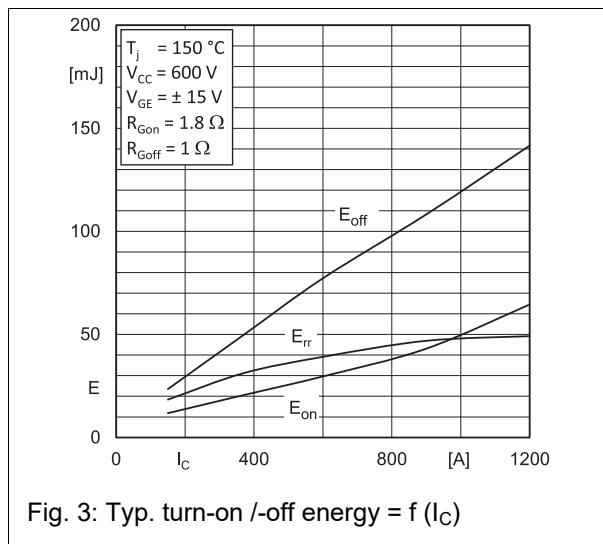
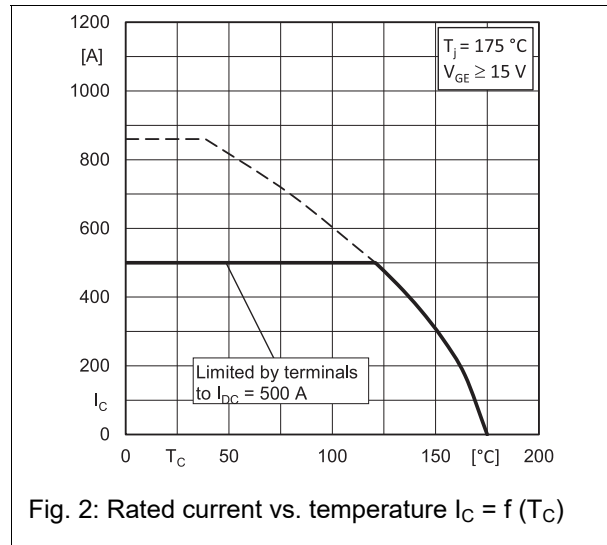
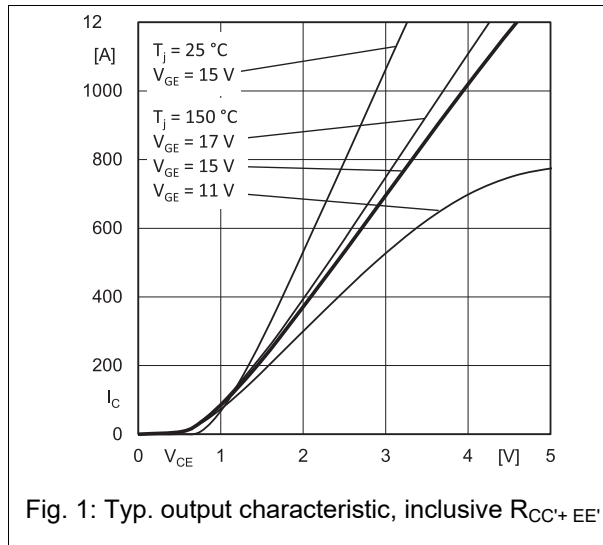
Characteristics

$T_C = 25^{\circ}\text{C}$, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 15\text{mA}$	5.3	5.8	6.3	V
I_{CES}	$V_{GE} = 0$; $V_{CE} = V_{CES}$; $T_J = 25^{\circ}\text{C}$			5.0	mA
$V_{CE(TO)}$	$T_J = 25(150)^{\circ}\text{C}$		0.8(0.7)	0.9(0.8)	V
r_{CE}	$V_{GE} = 15\text{V}$, $T_J = 25(150)^{\circ}\text{C}$		1.60(2.50)	1.90(2.70)	m Ω
$V_{CE(sat)}$	$I_C = 600\text{A}$; $V_{GE} = 15\text{V}$; chip level		1.85	2.10	V
C_{ies}	under following conditions		116		nF
C_{oes}	$V_{GE} = 0$, $V_{CE} = 25\text{V}$, $f = 1\text{MHz}$		22		
C_{res}			14		
L_{CE}			15		nH
R_{CC+EE}	res., terminal-chip $T_C = 25(125)^{\circ}\text{C}$		0.55(0.85)		m Ω
$t_{d(on)}$	under following conditions: $V_{CC} = 600\text{V}$, $I_C = 600\text{A}$		444		ns
t_r	$R_{Gon} = R_{Goff} = 1\Omega$, $T_J = 150^{\circ}\text{C}$		169		ns
$t_{d(off)}$	$V_{GE} = \pm 15\text{V}$		705		ns
t_f			231		ns
$E_{on}(E_{off})$			55(36)		mJ
Inverse Diode under following conditions:					
$V_F = V_{EC}$	$I_F = 600\text{A}$; $V_{GE} = 0\text{V}$; $T_J = 25^{\circ}\text{C}$		1.75	2.10	V
$V_{(FO)}$	$T_J = 25(150)^{\circ}\text{C}$		1.3(0.9)	1.5(1.1)	V
r_F	$T_J = 25(150)^{\circ}\text{C}$		1.6(2.3)	1.8(2.5)	m Ω
I_{RRM}	$I_F = 600\text{A}$; $T_J = 150^{\circ}\text{C}$		460		A
Q_{rr}	$di/dt = 2600\text{A/us}$		105		μC
E_{rr}	$V_{GE} = 15\text{V}$		31		mJ
Thermal Characteristics					
$R_{th(j-c)}$	per IGBT			0.040	K/W
$R_{th(j-c)D}$	per Inverse Diode			0.065	K/W
$R_{th(c-s)}$	per module			0.0125	K/W
Mechanical Data					
M_s	to heatsink M6	3		5	Nm
M_t	to terminals M6	2.5		5	Nm
Weight	typical			350	g
Temperature Sensor					
R_{100}	$T_C = 100^{\circ}\text{C}$ ($R_{25} = 5\text{ k}\Omega$)		493 $\pm$ 5%		Ω
$B_{100/125}$	$R(T) = R_{100} \exp[B_{100/125}(1/T - 1/T_{100})]$; $T[K]$:		3550 $\pm$ 2%		K

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